September 1995
Revised February 2005

FAIRCHILD
SEMICONDUCTOR®

74VHC132
Quad 2-Input NAND Schmitt Trigger

General Description

The VHC132 is an advanced high speed CMOS 2-input NAND Schmitt Trigger Gate fabricated with silicon gate CMOS technology. It achieves the high-speed operation similar to Bipolar Schottky TTL while maintaining the CMOS low power dissipation. Pin configuration and function are the same as the VHC00 but the inputs have hysteresis between the positive-going and negative-going input thresholds, which are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals. Thus greater noise margin then conventional gates is provided. An input protection circuit ensures that 0V to 7V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5V to 3V systems and two supply systems such as battery backup. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

- High Speed: t_{PD} = 3.9 ns (typ) at V_{CC} = 5 V
- Power down protection is provided on all inputs
- Low power dissipation: I_{CC} = 2 μA (max) at T_A = 25°C
- Low noise: V_{OLP} = 0.8 V (max)
- Pin and function compatible with 74HC132

Ordering Code:
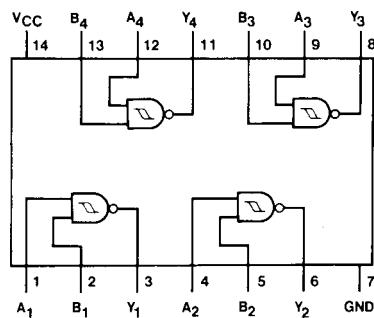
| Order Number	Package Number	Package Description
74VHC132M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VHC132SJ	M14D	Pb-Free 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHC132MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74VHC132MTCX_NL (Note 1)	MTC14	Pb-Free 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74VHC132N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.
Pb-Free package per JEDEC J-STD-020B.
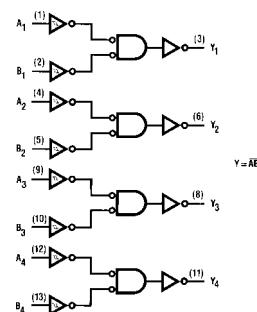
Note 1: "_NL" indicates Pb-Free package (per JEDEC J-STD-020B). Device available in Tape and Reel only.

74VHC132 Quad 2-Input NAND Schmitt Trigger

74VHC132

Connection Diagram

Pin Descriptions

Pin Names	Description
A_n, B_n	Inputs
Y_n	Outputs

Logic Diagram

$Y = \overline{AB}$

Truth Table

A	B	Y
L	L	H
L	H	H
H	L	H
H	H	L

Absolute Maximum Ratings(Note 2)

Supply Voltage (V_{CC})	$-0.5V$ to $+7.0V$
DC Input Voltage (V_{IN})	$-0.5V$ to $+7.0V$
DC Output Voltage (V_{OUT})	$-0.5V$ to $V_{CC} + 0.5V$
Input Diode Current (I_{IK})	-20 mA
Output Diode Current (I_{OK})	±20 mA
DC Output Current (I_{OUT})	±25 mA
DC V_{CC}/GND Current (I_{CC})	±50 mA
Storage Temperature (T_{STG})	$-65°C$ to $+150°C$
Lead Temperature (T_L)	
(Soldering, 10 seconds)	$260°C$

Recommended Operating Conditions (Note 3)

Supply Voltage (V_{CC})	2.0V to +5.5V
Input Voltage (V_{IN})	0V to +5.5V
Output Voltage (V_{OUT})	0V to V_{CC}
Operating Temperature (T_{OPR})	$-40°C$ to $+85°C$

Note 2: Absolute Maximum Ratings are values beyond which the device may be damaged or have its useful life impaired. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside databook specifications.

Note 3: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	$T_A = 25°C$			$T_A = -40°C$ to $+85°C$		Units	Conditions	
			Min	Typ	Max	Min	Max			
V_P	Positive	3.0			2.20		2.20			
	Threshold Voltage	4.5			3.15		3.15	V		
		5.5			3.85		3.85			
V_N	Negative	3.0	0.90			0.90				
	Threshold Voltage	4.5	1.35			1.35		V		
		5.5	1.65			1.65				
V_H	Hysteresis	3.0	0.30		1.20	0.30	1.20			
	Output Voltage	4.5	0.40		1.40	0.40	1.40	V		
		5.5	0.50		1.60	0.50	1.60			
V_{OH}	HIGH Level	2.0	1.9	2.0		1.9			$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -50$ µA
	Output Voltage	3.0	2.9	3.0		2.9		V		
		4.5	4.4	4.5		4.4				
		3.0	2.58			2.48		V		$I_{OH} = -4$ mA
		4.5	3.94			3.80				$I_{OH} = -8$ mA
V_{OL}	LOW Level	2.0		0.0	0.1		0.1		$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 50$ µA
	Output Voltage	3.0		0.0	0.1		0.1	V		
		4.5		0.0	0.1		0.1			
		3.0			0.36		0.44	V		$I_{OL} = 4$ mA
		4.5			0.36		0.44			$I_{OL} = 8$ mA
I_{IN}	Input Leakage Current	0–5.5			±0.1		±1.0	µA	$V_{IN} = 5.5V$ or GND	
I_{CC}	Quiescent Supply Current	5.5			2.0		20.0	µA	$V_{IN} = V_{CC}$ or GND	

Noise Characteristics
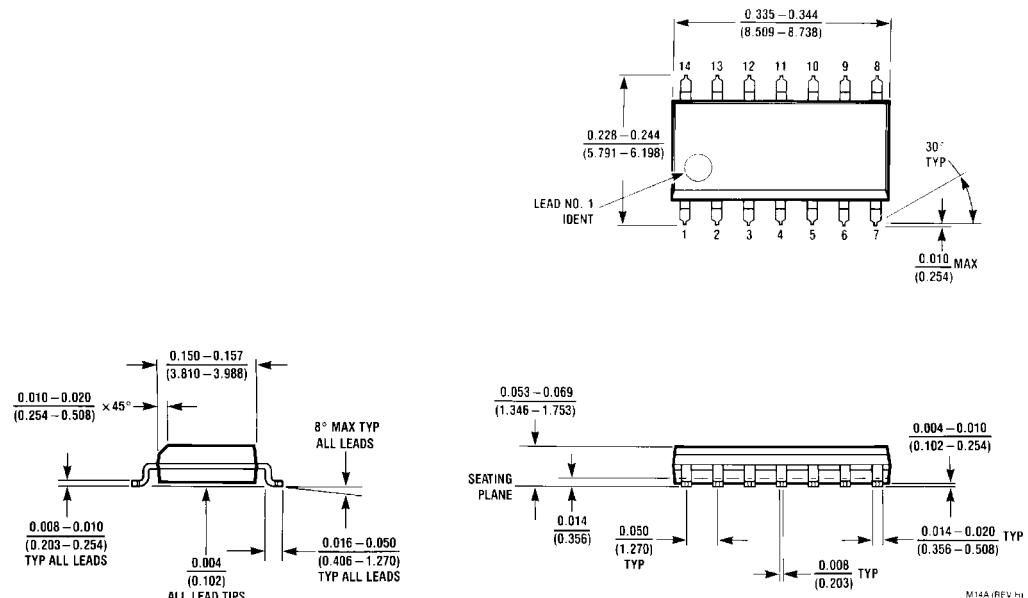
Symbol	Parameter	V_{CC} (V)	$T_A = 25°C$ Typ	$T_A = 25°C$ Limit	Units	Conditions
V_{OLP} (Note 4)	Quiet Output Maximum Dynamic V_{OL}	5.0	0.3	0.8	V	C_L = 50 pF
V_{OLV} (Note 4)	Quiet Output Maximum Dynamic V_{OL}	5.0	−0.3	−0.8	V	C_L = 50 pF
V_{IHD} (Note 4)	Maximum HIGH Level Dynamic Input Voltage	5.0		3.5	V	C_L = 50 pF
V_{ILD} (Note 4)	Maximum LOW Level Dynamic Input Voltage	5.0		1.5	V	C_L = 50 pF

Note 4: Parameter guaranteed by design

AC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	$T_A = 25°C$ Min	$T_A = 25°C$ Typ	$T_A = 25°C$ Max	$T_A = -40°C$ to $+85°C$ Min	$T_A = -40°C$ to $+85°C$ Max	Units	Conditions
t_{PHL} t_{PLH}	Propagation Delay	3.3 ± 0.3		6.1	11.9	1.0	14.0	ns	C_L = 15 pF
				8.0	15.4	1.0	17.5		C_L = 50 pF
		5.0 ± 0.5		3.9	7.7	1.0	9.0	ns	C_L = 15 pF
				5.9	9.7	1.0	11.0		C_L = 50 pF
C_{IN}	Input Capacitance			4	10		10	pF	V_{CC} = Open
C_{PD}	Power Dissipation Capacitance			16				pF	(Note 5)
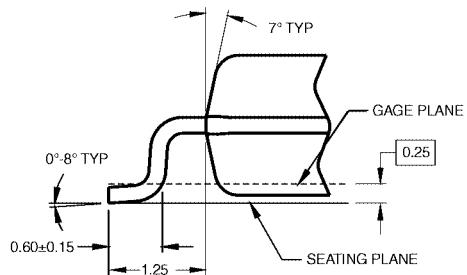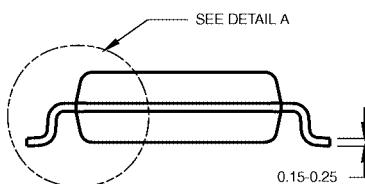
Note 5: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained from the equation: I_{CC} (opr.) = $C_{PD} * V_{CC} * I_{IN} + I_{CC}/4$ (per gate)

Physical Dimensions inches (millimeters) unless otherwise noted

0.335 − 0.344
(8.509 − 8.738)

14 13 12 11 10 9 8

0.228 − 0.244
(5.791 − 6.198)

LEAD NO. 1
IDENT

1 2 3 4 5 6 7

30°
TYP

0.010
(0.254) MAX

0.150 − 0.157
(3.810 − 3.988)

0.010 − 0.020
(0.254 − 0.508) × 45°

8° MAX TYP
ALL LEADS

0.008 − 0.010
(0.203 − 0.254)
TYP ALL LEADS

0.004
(0.102)
ALL LEAD TIPS

0.016 − 0.050
(0.406 − 1.270)
TYP ALL LEADS

0.053 − 0.069
(1.346 − 1.753)

0.004 − 0.010
(0.102 − 0.254)

SEATING
PLANE

0.014
(0.356)

0.050
(1.270)
TYP

0.008
(0.203) TYP

0.014 − 0.020
(0.356 − 0.508) TYP

M14A (REV H)

**14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
Package Number M14A**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)

10.2±0.1

-A-

1.1 TYP

14

8

7.8

5.3±0.1

-B-

3.9

PIN #1 IDENT.

1

7

⌒ 0.2 C B A
ALL LEAD TIPS

14   13   9   8

5.01 TYP

9.27 TYP

1   2   6   7

(2.13 TYP)

1.27 TYP

0.6 TYP

LAND PATTERN RECOMMENDATION

ALL LEAD TIPS

2.1 MAX.

⌒ 0.1 C

1.8±0.1

-C-

0.15±0.05

1.27 TYP

0.35-0.51

⊕ 0.12 Ⓜ C A

DIMENSIONS ARE IN MILLIMETERS

SEE DETAIL A

0.15-0.25

7° TYP

GAGE PLANE

0°-8° TYP

0.25

0.60±0.15

1.25

SEATING PLANE

DETAIL A
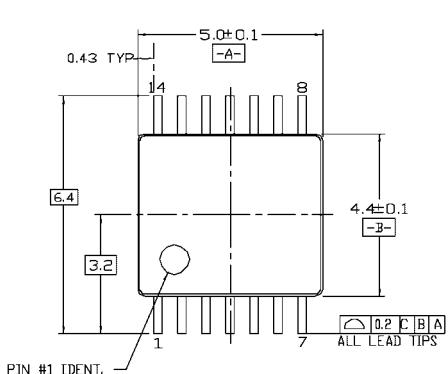
NOTES:
A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
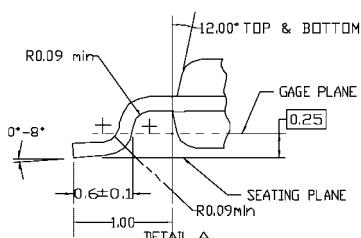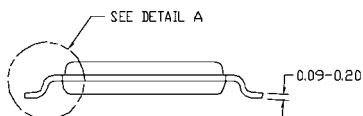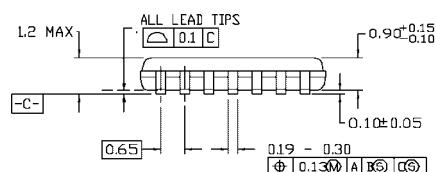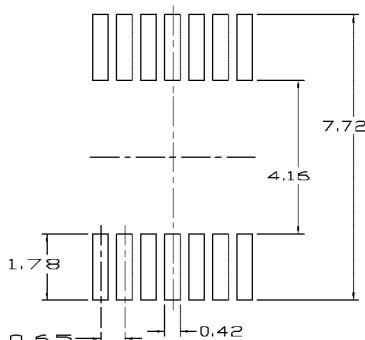
M14DRevB1

Pb-Free 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
**Package Number M14D**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

5.0±0.1
-A-

0.43 TYP

14   8

6.4

4.4±0.1
-B-

3.2

1

7

△ 0.2 C B A
ALL LEAD TIPS

PIN #1 IDENT.

7.72

4.16

1.78

0.65   0.42

LAND PATTERN RECOMMENDATION

1.2 MAX

ALL LEAD TIPS
△ 0.1 C

0.90 +0.15 -0.10

-C-

0.10±0.05

0.65

0.19 - 0.30

⊕ 0.13 Ⓜ A B Ⓢ C Ⓢ

SEE DETAIL A

0.09-0.20

12.00° TOP & BOTTOM

R0.09 min

GAGE PLANE

0°-8°

0.25

0.6±0.1

R0.09 min

SEATING PLANE

1.00

DETAIL A
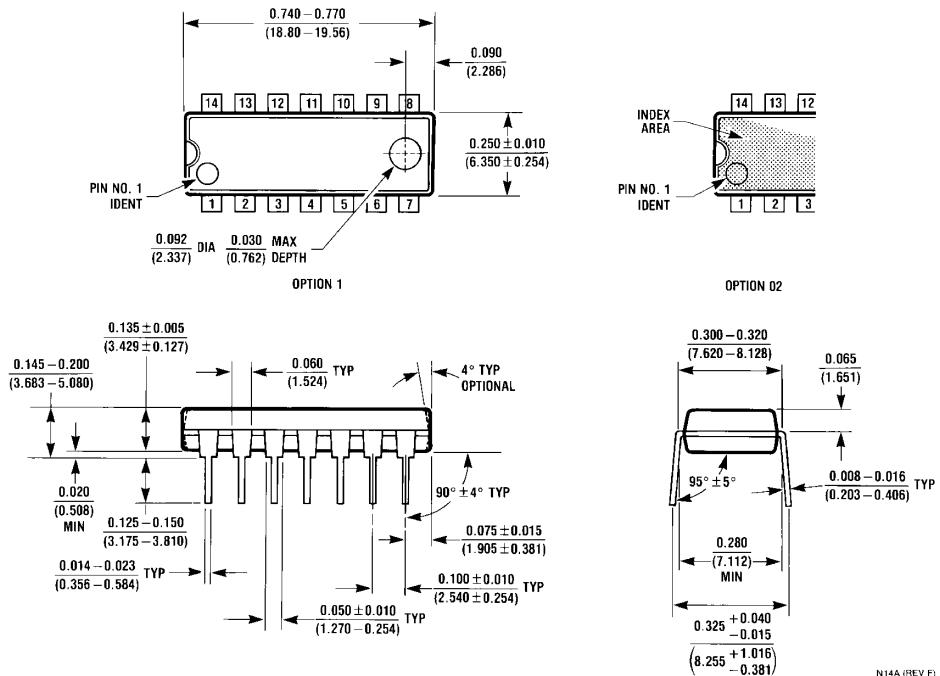
NOTES:

A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6, DATED 7/93
B. DIMENSIONS ARE IN MILLIMETERS
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1982

MTC14revD

**14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Package Number MTC14**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
Package Number N14A

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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